FUJITSU SEMICONDUCTOR DATA SHEET

### DS04-13513-1E

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# Linear IC Converter CMOS D/A Converter for Digital Tuning (12-channel, 8-bit, on-chip OP amp., low-voltage)

# **MB88146A**

### DESCRIPTION

The MB88146A is an 8-bit D/A converter with twelve built-in channels. The 12 analog outputs each have a builtin OP amplifier with large current drive-capability.

The data input/output format is CS (chip select) with serial bus connection available.

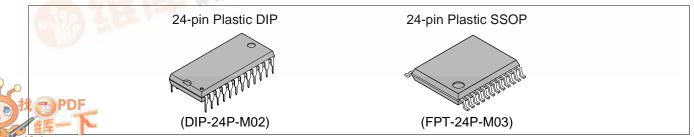
A built-in 12-bit I/O expander enables serial  $\leftrightarrow$  parallel conversion (8 of the 12 bits can also be used for analog output).

This product can be used for microcontroller port expansion, electronic level adjustment, replacement of semifixed resistance for tuning, etc.

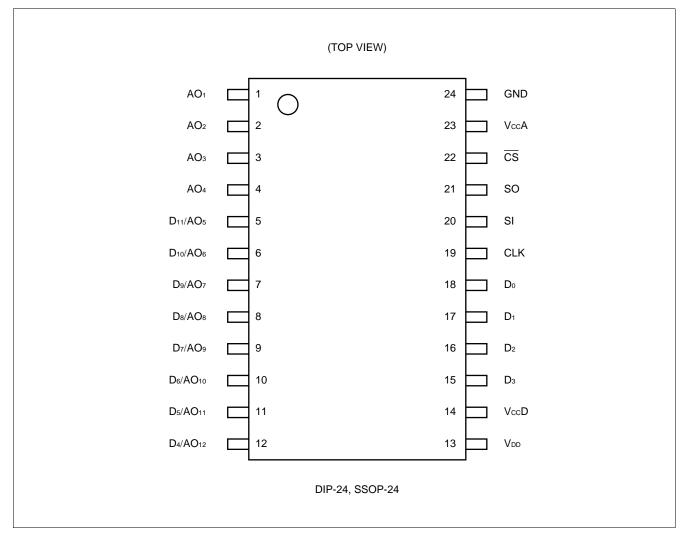
### FEATURES

- Ultra low power consumption (1.2 mW/chl: typical)
- Ultra compact package
- Built-in 12-channel R-2R type 8-bit D/A converter
- Built-in 12-bit I/O expander (8 bits also function as analog output)
- Built-in analog output amplifier (sink current 1.0 mA maximum, source current 1.0 mA maximum)
- Built-in power-on detection circuit (initialized at detection of VccD power-on)
- MCU interface compatible with 3 V to 5 V systems
- Power divided into MCU interface power supply (VccD) and OP amplifier power supply (VccA), D/A converter power supply (VccD)
- Analog output capability from 0 V to VccA
- Serial data I/O operates to maximum of 2.5 MHz (in cascade connection, up to 2.5 MHz when VccD = 5 V, up to 1.5 MHz when VccD = 3 V)
- CMOS process
- Choice of two packages: SDIP-24 pin and SSOP-24 pin.

### PACKAGES



### ■ PIN ASSIGNMENT

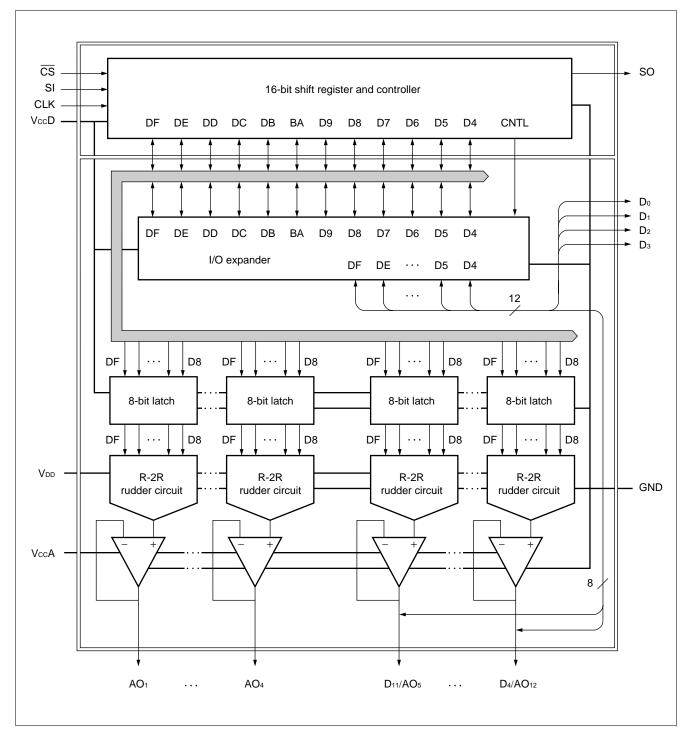


### ■ PIN DESCRIPTION

| Pin no.  | Pin name                           | Description   |
|----------|------------------------------------|---|
| 1 to 4   | AO <sub>1</sub> to AO <sub>4</sub> | D/A converter analog output pins (VDD to GND output).<br>(Default: output #00 setting level)  |
| 5 to 12  | D11/AO5 to<br>D4/AO12              | These pins may be used either as I/O expander parallel input/output (VccA/<br>GND output 0.5 VccA/0.2 VccA input) or D/A converter analog output (Vbb to<br>GND output).<br>Pin status is controlled by input data.<br>See "■Data Configuration". (Default: Input mode, Hi-Z state) |
| 13       | VDD*1                              | D/A converter reference power pin.  |
| 14       | VccD*1                             | MCU interface power supply pin (power supply for I/O expander).   |
| 15 to 18 | D₃ toD₀                            | I/O expander parallel input/output pins.<br>(VccD/GND output: When VccD ≧ 4.0 V, 0.5 VccD/0.2 VccD input,<br>When VccD < 4.0 V, 2 V/0.2 VccD input)<br>Pin status is controlled by input data.<br>See "■Data Configuration." (Default: Input mode, Hi-Z state)                      |
| 19       | CLK*2                              | Shift clock signal input pin.<br>When $\overline{CS} = $ "L," SI data is loaded into the shift register at the rising edge of the shift clock.  |
| 20       | SI*2                               | Data input pin (serial input pin).<br>Used for 16-bit serial data input.  |
| 21       | SO                                 | Data output pin (serial output pin).<br>The first bit (LSB) data of the 16-bit shift register is output simultaneously with<br>the falling edge of the shift clock.<br>When CS output = "H," this pin goes to high impedance state.   |
| 22       | CS*2                               | Chip select signal input pin.<br>Input to shift registers is enabled when the $\overline{CS}$ signal falling edges. Shift register contents can be executed when the $\overline{CS}$ signal rising edges.   |
| 23       | VccA*1                             | Analog unit power supply pin (OP amplifier power supply).   |
| 24       | GND                                | Common GND pin.   |

\*1: Be sure that VccA  $\ge$  VccD, and that VccA  $\ge$  VDD. \*2: Do not leave this pin in floating state.

### BLOCK DIAGRAM



### ■ DATA CONFIGURATION

### 1. Data Configuration

| DF | DE | DD | DC | DB | DA | D9 | D8 | D7 | D6 | D5 | D4 | D3 | D2 | D1 | D0 |  |
|----|----|----|----|----|----|----|----|----|----|----|----|----|----|----|----|--|
|    |    |    |    |    |    |    |    |    |    |    |    |    |    |    |    |  |

### 2. Channel Select

| D3 | D2 | D1 | D0 | Function                                     |
|----|----|----|----|--|
| 0  | 0  | 0  | 0  | Don't Care/special function                  |
| 0  | 0  | 0  | 1  | AO1 selected                                 |
| 0  | 0  | 1  | 0  | AO <sub>2</sub> selected                     |
| to | to | to | to | to   |
| 1  | 0  | 1  | 1  | AO11 selected                                |
| 1  | 1  | 0  | 0  | AO <sub>12</sub> selected                    |
| 1  | 1  | 0  | 1  | I/O expander (serial $\rightarrow$ parallel) |
| 1  | 1  | 1  | 0  | I/O expander (parallel $\rightarrow$ serial) |
| 1  | 1  | 1  | 1  | Expander status register (ESR)               |

### 3. Setting Data

| DF | DE | DD | DC | DB | DA | D9 | D8 | D7 | D6 | D5 | D4 | Analog output voltage level            |  |  |
|----|----|----|----|----|----|----|----|----|----|----|----|--|--|--|
| ×  | ×  | ×  | ×  | ×  | ×  | ×  | ×  | 0  | 0  | 0  | 0  | Don't Care                             |  |  |
| to | Don't Care                             |  |  |
| ×  | ×  | ×  | ×  | ×  | ×  | ×  | ×  | 1  | 0  | 1  | 1  | Don't Care                             |  |  |
| 0  | 0  | 0  | 0  | 0  | 0  | 0  | 0  | 1  | 1  | 0  | 0  | GND (all channels)                     |  |  |
| 0  | 0  | 0  | 0  | 0  | 0  | 0  | 1  | 1  | 1  | 0  | 0  | $V_{DD}/256 \times 1$ (all channels)   |  |  |
| 0  | 0  | 0  | 0  | 0  | 0  | 1  | 0  | 1  | 1  | 0  | 0  | $V_{DD}/256 \times 2$ (all channels)   |  |  |
| to                                     |  |  |
| 1  | 1  | 1  | 1  | 1  | 1  | 1  | 0  | 1  | 1  | 0  | 0  | $V_{DD}/256 \times 254$ (all channels) |  |  |
| 1  | 1  | 1  | 1  | 1  | 1  | 1  | 1  | 1  | 1  | 0  | 0  | $V_{DD}/256 \times 255$ (all channels) |  |  |
| ×  | ×  | ×  | ×  | ×  | ×  | ×  | ×  | 1  | 1  | 0  | 1  | Hi-Z (I/O expander state)*             |  |  |
| ×  | ×  | ×  | ×  | ×  | ×  | ×  | ×  | 1  | 1  | 1  | 0  | Reset (state when power is ON)         |  |  |
| ×  | ×  | ×  | ×  | ×  | ×  | ×  | ×  | 1  | 1  | 1  | 1  | Don't Care                             |  |  |

• Don't Care/special function (Channel select = "0000")

 $\times$ : Don't care \*: Hi-Z output on all channels of AO<sub>5</sub> through AO<sub>12</sub>

| DF | DE | DD | DC | DB | DA | D9 | D8 | D7 | D6 | D5 | D4 | Analog output voltage level |
|----|----|----|----|----|----|----|----|----|----|----|----|-----------------------------|
| 0  | 0  | 0  | 0  | 0  | 0  | 0  | 0  | 0  | 0  | 0  | 0  | GND                         |
| 0  | 0  | 0  | 0  | 0  | 0  | 0  | 1  | 0  | 0  | 0  | 0  | $V_{DD}/256 	imes 1$        |
| 0  | 0  | 0  | 0  | 0  | 0  | 1  | 0  | 0  | 0  | 0  | 0  | $V_{DD}/256 \times 2$       |
| 0  | 0  | 0  | 0  | 0  | 0  | 1  | 1  | 0  | 0  | 0  | 0  | $V_{DD}/256 	imes 3$        |
| to                          |
| 1  | 1  | 1  | 1  | 1  | 1  | 0  | 1  | 0  | 0  | 0  | 0  | $V_{DD}/256 \times 253$     |
| 1  | 1  | 1  | 1  | 1  | 1  | 1  | 0  | 0  | 0  | 0  | 0  | $V_{DD}/256 	imes 254$      |
| 1  | 1  | 1  | 1  | 1  | 1  | 1  | 1  | 0  | 0  | 0  | 0  | $V_{DD}/256 \times 255$     |
| ×  | ×  | ×  | ×  | ×  | ×  | ×  | ×  | 0  | 0  | 0  | 1  | Hi-Z (I/O expander state)*  |
| ×  | ×  | ×  | ×  | ×  | ×  | ×  | ×  | 0  | 0  | 1  | 0  | Don't Care                  |
| to | Don't Care                  |
| ×  | ×  | ×  | ×  | ×  | ×  | ×  | ×  | 1  | 1  | 1  | 1  | Don't Care                  |

• D/A Converter (Channel select = "0001" to "1100")

×: Don't care \*: Only AO5 through AO12 output is valid

I/O Expander [Channel select = "1101"]: Serial → Parallel Conversion
 Performs parallel conversion of data bits D4 to DF for output on pins D₀ to D11.
 Note that only those pins designated for output in the ESR (expander status register) are output.

Shift register

| ⇒ | DF           | DE           | DD           | DC           | DB           | DA           | D9           | D8           | D7           | D6             | D5           | D4           | D3   | D2      | D1     | D0     | $\Rightarrow$ |
|---|--------------|--------------|--------------|--------------|--------------|--------------|--------------|--------------|--------------|----------------|--------------|--------------|------|---------|--------|--------|---------------|
|   | $\downarrow$   | $\downarrow$ | $\downarrow$ |      |         |        |        |               |
|   | <b>D</b> 11  | <b>D</b> 10  | D9           | D8           | D7           | $D_6$        | D5           | D4           | Dз           | D <sub>2</sub> | D1           | $D_0$        | Para | allel I | /O pir | าร (อเ | utput state)  |

• I/O Expander [Channel select = "1110"]: Parallel  $\rightarrow$  Serial Conversion

Writes data from  $D_0$  to  $D_{11}$  pins to bits D4 to DF in the shift register.

Data is output to the SO pin on the shift clock (CLK) signal (The first 4 bits output data D0 to D3, so the converted output should be read as data bits 5 through 16.).

Note that the data value is "0" for pins designated for output in the ESR (expander status register) as well as analog output pins.

Shift register

| $\Rightarrow$ | DF         | DE          | DD         | DC         | DB         | DA             | D9         | D8         | D7         | D6             | D5         | D4         | D3   | D2       | D1    | D0    |             |
|---------------|------------|-------------|------------|------------|------------|----------------|------------|------------|------------|----------------|------------|------------|------|----------|-------|-------|-------------|
|               | $\uparrow$ | $\uparrow$  | $\uparrow$ | $\uparrow$ | $\uparrow$ | $\uparrow$     | $\uparrow$ | $\uparrow$ | $\uparrow$ | $\uparrow$     | $\uparrow$ | $\uparrow$ |      |          |       |       |             |
|               | D11        | <b>D</b> 10 | D9         | D8         | D7         | D <sub>6</sub> | D₅         | D4         | D₃         | D <sub>2</sub> | D1         | Do         | Para | allel I/ | O pin | s (ou | tput state) |

• Expander Status Register [Channel select = "1111"]

Shift register

| $\Rightarrow$ | DF           | DE           | DD           | DC           | DB           | DA           | D9           | D8           | D7           | D6           | D5           | D4           | ESR |
|---------------|--------------|--------------|--------------|--------------|--------------|--------------|--------------|--------------|--------------|--------------|--------------|--------------|-----|
|               | $\downarrow$ |     |
|               | D11          | <b>D</b> 10  | D9           | D8           | D7           | $D_6$        | D₅           | D4           | Dз           | $D_2$        | D1           | $D_0$        |     |

This register sets the status of each pin.

| Setting | Pin status  |
|---------|---|
| "O"     | <ul> <li>Input standby status (Hi-Z output)</li> <li>D<sub>11</sub> to D<sub>4</sub> pins used for analog output should be set to "0."</li> </ul> |
| "1"     | Output state  |

Note: After power VccD is turned on, the state of pins and registers is as follows.

| Pin                              | State                    |
|----------------------------------|--------------------------|
| AO1 to AO4                       | "L" output               |
| D11/AO5 to D4/AO12               | Hi-Z state (input state) |
| D <sub>3</sub> to D <sub>0</sub> | Hi-Z state (input state) |

| Register                       | State   |
|--------------------------------|---|
| Shift register                 | Bits DF to D8 are "0," and D7 to D0 are not defined (retain prior state). |
| D/A register                   | All reset to "0."   |
| Parallel output register       | Not defined (retain prior state).   |
| Expander status register (ESR) | All reset to "0."   |

• ESR settings have priority in determining pin states. Switching between input standby state and analog output state is enabled even when the ESR value is "1." When the ESR value returns to "0", the pin returns to its previously defined state.

• In input standby state with AO set for Hi-Z output, the AO output setting can be used for transition to AO output state.

### ABSOLUTE MAXIMUM RATINGS

| Devementer            | Symphol                    | Conditio                             |    | Ra   | ting       | 11   |
|-----------------------|----------------------------|--------------------------------------|----|------|------------|------|
| Parameter             | Symbol                     | Condition                            | 15 | Min. | Max.       | Unit |
|                       | VccA                       |                                      |    | -0.3 | +7.0       | V    |
| Power supply voltage  | VccD                       | Based on GND<br>(Ta = +25°C)         |    | -0.3 | VccA*      | V    |
|                       | Vdd                        | (14 - 120 0)                         |    | -0.3 | VccA*      | V    |
| Input voltage 1       | Vin1                       | SI, CLK, <u>CS</u> ,                 |    | -0.3 | VccD + 0.3 | V    |
| Output voltage 1      | Vout1                      | SO, D <sub>0</sub> to D <sub>3</sub> |    | -0.3 | VccD + 0.3 | V    |
| Input voltage 2       | Vin2                       |                                      |    | -0.3 | VccA + 0.3 | V    |
| Output voltage 2      | Vout2                      | D4 to D11                            |    | -0.3 | VccA + 0.3 | V    |
| Power consumption     | nsumption P <sub>D</sub> — |                                      |    |      | 250        | mW   |
| Operating temperature | erating temperature Ta —   |                                      |    | -20  | +85        | °C   |
| Storage temperature   | Tstg                       | _                                    |    | -55  | +150       | °C   |

\* : VccA  $\geq$  VccD, VccA  $\geq$  Vdd

WARNING: Semiconductor devices can be permanently damaged by application of stress (voltage, current, temperature, etc.) in excess of absolute maximum ratings. Do not exceed these ratings.

### ■ RECOMMENDED OPERATING CONDITIONS

| Parameter                         | Symbol | Conditions        |      | Unit |      |      |
|-----------------------------------|--------|-------------------|------|------|------|------|
| Parameter                         | Symbol | Conditions        | Min. | Тур. | Max. | Unit |
|                                   | VccA   | —                 | 4.5  | 5.0  | 5.5  | V    |
| Dower oupply voltage              | VccD   | $VccA \geqq VccD$ | 2.7  | _    | VccA | V    |
| Power supply voltage              | Vdd    | $VccA \geqq Vdd$  | 2.0  | _    | VccA | V    |
|                                   | GND    | —                 |      | 0    | _    | V    |
| Analog output ourrent             | AL     | Source current    |      |      | 1.0  | mA   |
| Analog output current             | Іан    | Sink current      |      | _    | 1.0  | mA   |
| Oscillation limit output capacity | Сог    | _                 | —    | _    | 1.0  | μF   |
| Operation temperature             | Та     | —                 | -20  |      | +85  | °C   |

WARNING: Recommended operating conditions are normal operating ranges for the semiconductor device. All the device's electrical characteristics are warranted when operated within these ranges.

Always use semiconductor devices within the recommended operating conditions. Operation outside these ranges may adversely affect reliability and could result in device failure.

No warranty is made with respect to uses, operating conditions, or combinations not represented on the data sheet. Users considering application outside the listed conditions are advised to contact their FUJITSU representative beforehand.

### ELECTRICAL CHARACTERISTIC

#### 1. DC Characteristics

(1) Digital section

| $(VccD \leq VccA,$ | Ta = −20°C | to +85°C) |
|--------------------|------------|-----------|
|--------------------|------------|-----------|

| Paramatar                      | Symbol                       | Din nomo                         | Conditions   |                | Value |                | Unit |
|--------------------------------|------------------------------|----------------------------------|--|----------------|-------|----------------|------|
| Farameter                      | Parameter Symbol Pin name Co |                                  | Conditions   | Min.           | Тур.  | Max.           | Unit |
| Power supply voltage           | VccD                         |                                  | —  | 2.7            | 5.0   | 5.5            | V    |
| Power supply current           | lccD                         | VccD                             | CLK =1 MHz,<br>(Unloaded)  | _              | 0.2   | 0.5            | mA   |
| Standby current                | IccS                         |                                  | CLK, SI, <del>CS</del> Stop<br>V <sub>in</sub> = V <sub>CC</sub> D or<br>GND | -10            | _     | +10            | μA   |
| Input leak current             | ILK1                         |                                  | $V_{in} = 0$ to $V_{CC}D$  | -10            | —     | +10            | μΑ   |
| "H" level input voltage        | VIH1                         | C <u>LK,</u> SI,<br>CS,          | $VccD \ge 4.0 V$   | 0.5 	imes VccD | —     | —              | V    |
| TT level input voltage         | V IH1                        | D₀ to D₃                         | VccD < 4.0 V   | 2.0            | _     | _              | V    |
| "L" level input voltage        | VIL1                         |                                  |  | _              | _     | 0.2 	imes VccD | V    |
| High-impedance leak<br>current | Iolk                         | SO                               | Vin = 0 to VccD  | -10            | _     | +10            | μΑ   |
| "H" level output voltage       | Vон1                         | SO,                              | Iон = -0.4 mA  | VccD-0.4       |       | _              | V    |
| "L" level output voltage       | Vol1                         | D <sub>0</sub> to D <sub>3</sub> | lo∟ = 2.5 mA   | _              | _     | 0.4            | V    |

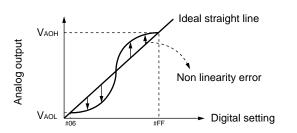
#### (2) D/A converter section

#### $(VccA = 5 V \pm 10\%, Ta = -20^{\circ}C \text{ to } +85^{\circ}C)$

| Deremeter                    | Sumbal                    |             | Conditions             |                            | 11   |      |      |      |
|------------------------------|---------------------------|-------------|------------------------|----------------------------|------|------|------|------|
| Parameter                    | Parameter Symbol Pin name |             | Conditions             | Min.                       | Тур. | Max. | Unit |      |
| Power supply voltage         | Vdd                       | Vdd         | $V_{DD} \leqq V_{CC}A$ | 2.0                        | 5.0  | 5.5  | V    |      |
| Power supply current         | DD                        | VDD         | $V_{DD} \leqq V_{CC}A$ | _                          | 1.2  | 2.5  | mA   |      |
| Resolution                   | Res                       |             | Unload                 | _                          | 8    |      | bits |      |
| Monotonic increase           | Rem                       | AO1 to AO12 |                        | $V_{DD} = V_{CC}A - 0.1 V$ | _    | 8    |      | bits |
| Nonlinearity error           | LE                        |             | Digital value: #06     | -1.5                       | _    | +1.5 | LSB  |      |
| Differential linearity error | DLE                       |             | to #FF                 | -1.0                       |      | +1.0 | LSB  |      |

Nonlinearity error: Deviation (error) in input/output curves with respect to an ideal straight line connecting output voltage at "06" and output voltage at "FF."

Differential linearity error: Deviation (error) in amplification with respect to theoretical increase in amplification per 1-bit increase in digital value.



Note: The value of V\_{AOH} and V\_{DD}, and the value of V\_{AOL} and GND are not necessarily equivalent.

### (3) Operational Amplifier/Analog output section

|                                    |                   |             |   | (VDD = VCO)       | cA = 5.0 V, T | $a = -20^{\circ}C$ to - | -85°C) |
|------------------------------------|-------------------|-------------|---|-------------------|---------------|-------------------------|--------|
| Parameter                          | Symbol            | Pin name    | in name Conditions                      |                   | Unit          |                         |        |
| Falailletei                        | Symbol            |             | Conditions                              | Min.              | Тур.          | Max.                    | Unit   |
| Power supply voltage               | Vcca              |             |   | 4.5               | 5.0           | 5.5                     | V      |
| Power supply current               | Ісса              | VccA        | #80 setting<br>(Unloaded)               |                   | 1.0           | 3.7                     | mA     |
| Input leak current                 | IILK2             |             | Vin = 0 to VccA                         | -10               | _             | +10                     | μA     |
| "H" level digital input<br>voltage | VIH2              |             | _                                       | $0.5 \times VccA$ | _             | _                       | V      |
| "L" level digital input voltage    | VIL2              | D4 to D11   | _                                       | _                 | _             | $0.2 \times VccA$       | V      |
| "H" level digital output voltage   | Vон2              |             | Іон = -0.4 mA                           | VccA-0.4          | _             | _                       | V      |
| "L" level digital output voltage   | Vol2              |             | lo∟ = 2.5 mA                            |                   | _             | 0.4                     | V      |
| Analog output minimum voltage 1    | VAOL1             |             | I <sub>AL</sub> = 0 A<br>#00 setting    | GND               | _             | 0.1                     | V      |
| Analog output minimum voltage 2    | V <sub>AOL2</sub> |             | I <sub>AL</sub> = 0.5 mA<br>#00 setting | -0.2              | GND           | 0.2                     | V      |
| Analog output minimum voltage 3    | Vaol3             | AO1 to AO12 | I <sub>AH</sub> = 0.5 mA<br>#00 setting | GND               | —             | 0.2                     | V      |
| Analog output minimum voltage 4    | VAOL4             |             | I <sub>AL</sub> = 1.0 mA<br>#00 setting | -0.3              | GND           | 0.3                     | V      |
| Analog output minimum voltage 5    | V <sub>AOL5</sub> |             | Iан = 1.0 mA<br>#00 setting             | GND               | _             | 0.3                     | V      |
| Analog output<br>maximum voltage 1 | Vaoh1             |             | I <sub>AL</sub> = 0 A<br>#FF setting    | VccA-0.1          | —             | VccA                    | V      |
| Analog output<br>maximum voltage 2 | Vaoh2             |             | IAL = 0.5 mA<br>#FF setting             | VccA-0.2          | —             | VccA                    | V      |
| Analog output<br>maximum voltage 3 | Vаонз             | AO1 to AO12 | I <sub>AH</sub> = 0.5 mA<br>#FF setting | VccA-0.2          | VccA          | VccA+0.2                | V      |
| Analog output<br>maximum voltage 4 | VAOH4             |             | I <sub>AL</sub> = 1.0 mA<br>#FF setting | VccA-0.3          | _             | VccA                    | V      |
| Analog output<br>maximum voltage 5 | VAOH5             |             | I <sub>AH</sub> = 1.0 mA<br>#FF setting | VccA-0.3          | VccA          | VccA+0.3                | V      |

 $\Lambda I$ **١** - 0 V T 20°C to 

Note: IAH: Analog output sink current IAL: Analog output source current

#### 2. AC Characteristics

• For operation at VccD = 5.0 V

| Baramatar   | Symbol         | Conditions             | Value |      |      | Unit |
|---|----------------|------------------------|-------|------|------|------|
| Parameter   | Symbol         | Conditions             | Min.  | Тур. | Max. | Unit |
| Clock "L" level pulse width                       | <b>t</b> ckl   | —                      | 200   | —    |      | ns   |
| Clock "H" level pulse width                       | <b>t</b> скн   | —                      | 200   | _    |      | ns   |
| Clock rise time                                   | <b>t</b> Cr    | —                      | _     | _    | 200  | ns   |
| Clock fall time                                   | <b>t</b> Cf    | —                      | _     | _    | 200  | ns   |
| Serial input setup time                           | <b>t</b> ssu   | —                      | 30    | _    |      | ns   |
| Serial input hold time                            | <b>t</b> shd   | —                      | 60    | _    |      | ns   |
| Serial output delay time                          | tsod           | See "Load condition 1" | 0     | 80   | 170  | ns   |
| CS input setup time                               | <b>t</b> csu   | —                      | 100   | _    |      | ns   |
| CS hold time                                      | tссн           | —                      | 200   | _    |      | ns   |
| CS "H" level hold time                            | <b>t</b> csн   | —                      | 100   | _    | _    | ns   |
| Data output enable time                           | tso            | —                      | _     | _    | 200  | ns   |
| Data output float time                            | <b>t</b> soz   | —                      | _     | _    | 200  | ns   |
| Parallel input setup time                         | <b>t</b> PSU   | —                      | 30    | _    |      | ns   |
| Parallel input hold time                          | <b>t</b> PHD   | —                      | 60    | _    | _    | ns   |
| Parallel output delay time                        | <b>t</b> POD   | See "Load condition 1" | _     | 100  | 170  | ns   |
| Analog output delay time                          | <b>t</b> aod   | See "Load condition 2" |       | 30   | 100  | μs   |
| Power supply rise time                            | tR             | —                      | _     | _    | 50   | ms   |
| Power-on reset non-startup power supply variation | $\Delta V_{R}$ | _                      | -10   |      | 10   | V/µs |

• For operation at VccD = 3.0 V  $^{*1}$ 

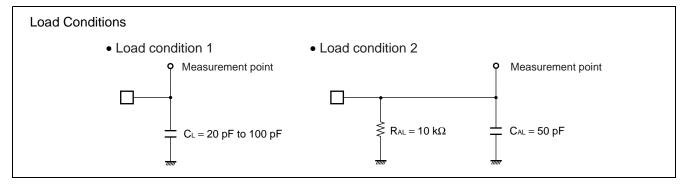
#### $(V cc D = 3.0 V, Ta = -20^{\circ}C to +85^{\circ}C)$

| Parameter                  | Symbol       | Conditions               | Value |      |      | Unit |
|----------------------------|--------------|--------------------------|-------|------|------|------|
| Farameter                  | Symbol       | Conditions               | Min.  | Тур. | Max. | Unit |
| Serial output delay time   | tsod         | See "Load condition 1"*2 | 0     | 120  | 300  | ns   |
| Parallel output delay time | <b>t</b> POD | See "Load condition 2"*3 | _     | 120  | 300  | ns   |

\*1: Items not listed are identical to characteristics for VccD = 5.0 V.

\*2: Cascade connection enabled at 1.5 MHz.

\*3: Applied to D0 to D3 operating at VccD.



| CLK                    | tckl               |      |              |
|------------------------|--------------------|------|--------------|
| SI                     |                    |      |              |
|                        | tssu +  +  +  tshD |      |              |
| so                     |                    | tsop |              |
| D₀ to D₁₁ (For input)  |                    |      |              |
| D₀ to D₁₁ (For output) |                    |      |              |
| AO1 to AO12            |                    |      | 90 %<br>10 % |

• Input/Output Timing (CS method)

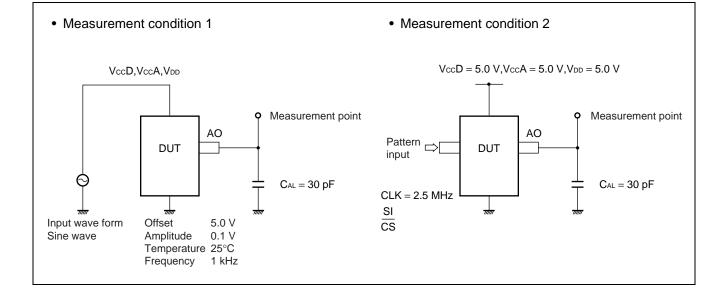
Power Supply Timing

| Power-On Timing       |  |  |
|-----------------------|--|--|
| VccD                  | 2.0 V<br>0.2 V   |  |
| Power-On Reset Non-St | rtup Supply Variation  |  |
| Upper limit, 5.5V     |  |  |
| VccD                  | $\Delta V \qquad \qquad \Delta V \qquad \qquad \Delta V \qquad \qquad \Delta V \qquad \qquad \Delta V = \frac{\Delta V}{\Delta T}$ |  |
| 2.7V, lower limit     |  |  |

### 3. Analog Output Noise Characteristic

|                                      |   |   | (VDD = VCCD = V |      | J.U V, | iα – + | 23 0) |
|--------------------------------------|---|---|-----------------|------|--------|--------|-------|
| Parameter                            | Symbol  | Conditions  | Measurement     |      | Value  |        | Unit  |
| Parameter                            | Symbol  | Conditions  | condition       | Min. | Тур.   | Max.   | Unit  |
| Digital supply noise reduction ratio | Psrd  | fnoise = 1 kHz  | 1               | —    | —      | 20     | dB    |
| Analog supply noise reduction ratio  | Psra  | fnoise = 1 kHz  | 1               |      |        | 20     | dB    |
| D/A supply noise reduction ratio     | Psrda   | fNOISE = 1 kHz  | 1               |      |        | 0      | dB    |
| Operating noise                      | V <sub>N1</sub>   | <ul> <li>During serial transfer</li> <li>During analog operation</li> <li>During Hi-Z commands.<br/>See "Operating Noise V<sub>N1</sub>."</li> </ul>  | 2               | -30  |        | 30     | mV    |
| I/O expander operating<br>noise 1    | Vn2   | <ul> <li>Serial → parallel conversion<br/>See "I/O Expander Operating<br/>Noise 1 V<sub>N2</sub>."<br/>During digital-only pin operation</li> <li>During parallel → serial conversion</li> <li>ESR setting<br/>During digital input/digital output<br/>switching</li> </ul> | 2               | -30  |        | 30     | mV    |
| I/O expander operating<br>noise 2    | • During serial → parallel conversio<br>See "I/O Expander Operating<br>Noise 2 V <sub>N3</sub> ." |   | 2               | -0.1 |        | 0.1    | V     |

 $(V_{DD} = V_{CC}D = V_{CC}A = 5.0 \text{ V}, \text{ Ta} = +25^{\circ}\text{C})$ 



| • | Analog | Output | Noise | Description |
|---|--------|--------|-------|-------------|
|---|--------|--------|-------|-------------|

| <ul> <li>Output Noise V<sub>N1</sub></li> <li>Noise to analog output during serial data transfer, analog operation, Hi-Z commands.</li> </ul>   |
|---|
|   |
| СLК   |
| si X  |
| Analog operation commands, Hi-Z commands  |
| CS  |
| AO× Analog output   |
| D11/AO5   |
| to<br>D₀/AQ <sub>12</sub> Digital input* ⇔ analog output  |
|   |
| $\begin{array}{c} AO_1 \\ to \\ AO_{12} \end{array} \longrightarrow \cdots \longrightarrow \begin{array}{c} V_{N1} \\ V_{N1} \\ V_{N1} \end{array}$   |
|   |
| <ul> <li>I/O Expander Operation Noise 1 V<sub>N2</sub></li> <li>Noise to analog output during parallel → serial conversion commands, serial → parallel conversion command for digital-only pins, or ESR setting commands for switching between digital input and digital output.</li> </ul> |
| СLК   |
| SI Parallel $\rightarrow$ serial conversion, serial $\rightarrow$ parallel conversion, ESR setting commands   |
| CS  |
|   |
| to<br>Do Parallel output  |
| D <sub>11</sub>   |
| to $D_0$ Digital input $\Leftrightarrow$ digital output   |
|   |
| to $V_{N2}$ $V_{N2}$  |
|   |

(Continued)

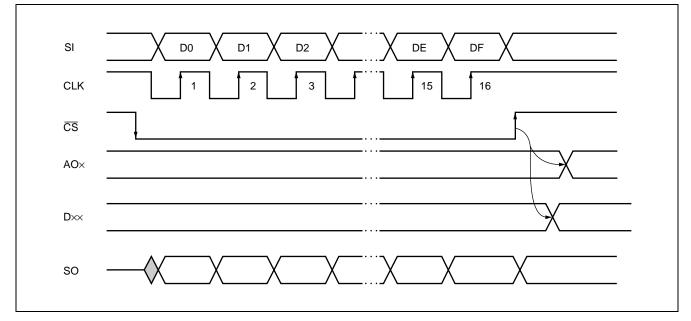
### (Continued)

| CL              | <   |          |
|-----------------|---|----------|
| SI              | Serial $\rightarrow$ parallel switching commands, ESR setting commands  |          |
| cs              |   |          |
| D11<br>to<br>D4 | Parallel output   |          |
|                 | AO <sub>5</sub> $\square$ | g output |
| AC<br>to        |   |          |

### ■ DATA INPUT/OUTPUT TIMING

#### MB88146A Data Input/Output Timing (Serial Bus Format)

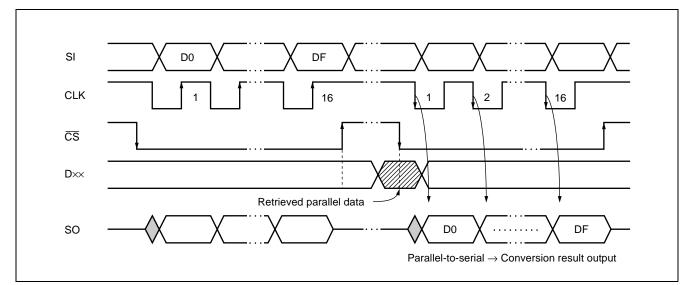
• D/A converter operation, and I/O expander (serial → parallel conversion) operation, and ESR writing operation.



Data input is enabled at the falling edge of the  $\overline{CS}$  signal. 16-bit data is input, and the shift register command is executed at the rising edge of  $\overline{CS}$ .

In D/A converter operation, the analog output selected at the rising edge of  $\overline{CS}$  is the conversion result. In serial  $\rightarrow$  parallel conversion, the digital output selected at the rising edge of  $\overline{CS}$  is the conversion result. In ESR write operation, ESR data is set and pin status determined at the rising edge of  $\overline{CS}$ .

• I/O expander (parallel  $\rightarrow$  serial conversion) operation



Data input is enabled at the falling edge of the  $\overline{CS}$  signal. 16-bit data (parallel  $\rightarrow$  serial conversion commands) is input and commands accepted at the rising edge of  $\overline{CS}$ . At the falling edge of  $\overline{CS}$ , data from the parallel input is loaded into bits D4 to DF of the shift register, and output from the SO pin timed to the falling edge of the CLK signal.

### ■ USAGE PRECAUTIONS

#### 1. Preventing Latch-Up

A condition known as "latch-up" may occur when the input or output pins of a CMOS IC device are exposed to voltages higher then VccD or VccA or lower than GND voltage, or when voltages are applied to the device in excess of rated values for VccD, VccA, or VpD to GND voltages. Latchup produces a rapid increase in power supply current, and may result in thermal destruction of elements. Users should take sufficient precautions to ensure that absolute maximum ratings are not exceeded at any time during use.

#### 2. Power Supply Pins

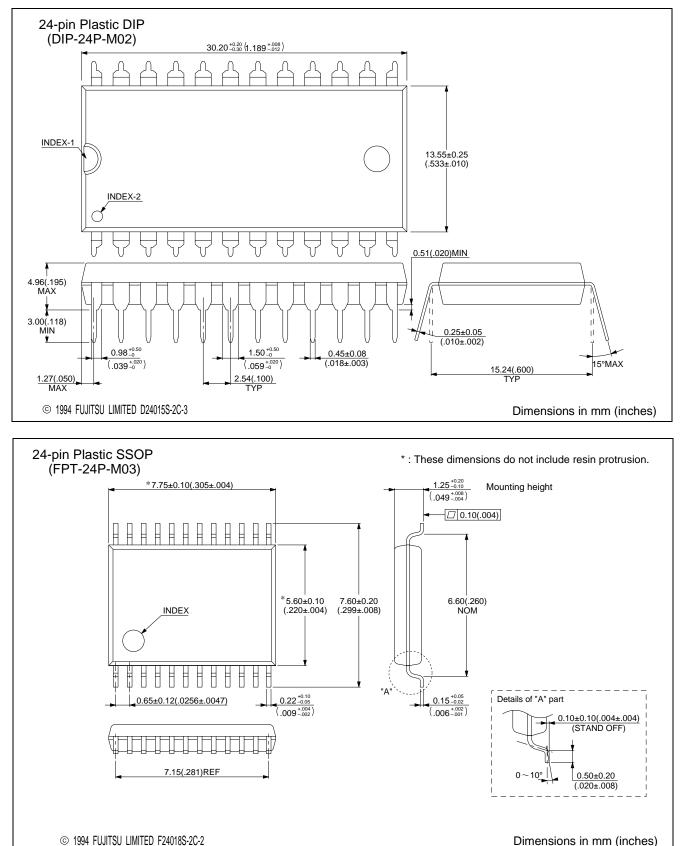
The power supply should be connected to the VccD, VccA, VDD, and GND terminals of the MB88146A with as low an impedance as possible.

In addition, it is recommended that ceramic capacitors or approximately 0.1  $\mu$ F be connected as bypass capacitors between the VccD, VccA, and VDD terminals and the GND terminals.

### ORDERING INFORMATION

| Part number | Package                              | Remarks |
|-------------|--------------------------------------|---------|
| MB88146AP   | 24-pin Plastic DIP<br>(DIP-24P-M02)  |         |
| MB88146APFV | 24-pin Plastic SSOP<br>(FPT-24P-M03) |         |

#### PACKAGE DIMENSIONS



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